

GSM1382SF

100V N-Channel MOSFET

Product Description

The N-Channel enhancement mode power field effect transistor is using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode.

The device is well suited for high efficiency fast switching applications.

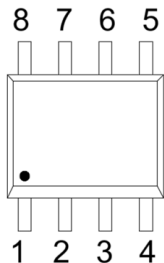
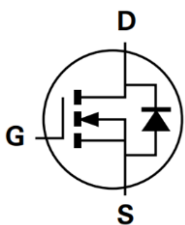
Features

- $R_{DS(ON)} = 8.4m\Omega @ V_{GS}=10V$
- $R_{DS(ON)} = 12m\Omega @ V_{GS}=4.5V$
- SOP-8L Package
- RoHS Compliant and Halogen Free

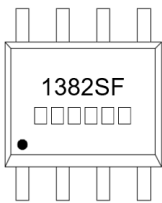
Applications

- MB / VGA / Vcore
- POL Applications
- SMPS

Packages & Pin Assignments

SOP-8L			Equivalent Circuit		
					
Pin	Symbol	Description	Pin	Symbol	Description
1	S	Source	8	D	Drain
2	S	Source	7	D	Drain
3	S	Source	6	D	Drain
4	G	Gate	5	D	Drain

Ordering and Marking Information

Ordering Information			
Part Number	Package	Part Marking	Quantity / Reel
GSM1382SF	SOP-8L	1382SF □□□□□□	4,000 PCS
GSM1382 1 2			
- Product Code: GSM1382 - Package Code: 1 is S for SOP-8L - Green Level: 2 is F for RoHS Compliant and Halogen Free			
Marking Information			
 - Product Code: 1382SF - GS Code: □□□□□□ •The dot indicates pin1			

Absolute Maximum Ratings (T_A = 25°C unless otherwise specified)

Symbol	Parameter	Value	Unit
V _{DSS}	Drain-Source Voltage	100	V
V _{GSS}	Gate-Source Voltage	±20	V
I _D	Continuous Drain Current	T _A =25°C	A
		T _A =70°C	
I _{DM}	Pulsed Drain Current ¹	40	A
I _{AS}	Single Pulse Avalanche Current, L = 0.1mH ¹	25	A
E _{AS}	Single Pulse Avalanche Energy, L = 0.1mH ¹	62.5	mJ
P _D	Power Dissipation	T _A =25°C	W
		T _A =70°C	
R _{θJA}	Thermal Resistance-Junction to Ambient ²	75	°C/W
T _J	Operating Junction Temperature Range	-55 to +150	°C
T _{STG}	Storage Temperature Range	-55 to +150	°C

NOTE:

- Single pulse width is limited by max junction temperature.
- The device was mounted on 1in² FR-4 board with 2oz.copper.

Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Static Characteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	100	-	-	V
I _{DSS}	Drain-Source Leakage Current	V _{DS} =100V, V _{GS} =0V	-	-	1	μA
I _{GSS}	Gate-Source Leakage Current	V _{DS} =0V, V _{GS} =±20V	-	-	±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	1.2	-	2.5	V
R _{DS(ON)}	Drain-Source On-Resistance	V _{GS} =10V, I _D =10A	-	7.4	8.4	mΩ
		V _{GS} =4.5V, I _D =5A	-	9.6	12	
g _{fs}	Forward Transconductance	V _{DS} =5V, I _D =10A	-	30	-	S
Dynamic Characteristics						
R _g	Gate Resistance	f=1MHz		1		Ω
C _{iSS}	Input Capacitance	V _{DS} =50V, V _{GS} =0V, f=1MHz	-	2180	2980	pF
C _{oss}	Output Capacitance		-	550	-	
C _{rss}	Reverse Transfer Capacitance		-	13	-	
Q _g	Total Gate Charge	V _{DS} =50V, I _D =10A V _{GS} =10V	-	39	58	nC
Q _{gs}	Gate-Source Charge		-	4.4	-	
Q _{gd}	Gate-Drain Charge		-	12	-	
t _{d(on)}	Turn-On Delay Time	V _{DD} =50V, I _D =10A V _{GS} =10V, R _g =6Ω	-	14	-	ns
t _r	Turn-On Rise Time		-	21	-	
t _{d(off)}	Turn-Off Delay Time		-	34	-	
t _f	Turn-Off Fall Time		-	24	-	
Diode Characteristics						
V _{SD}	Diode Forward Voltage	V _{GS} =0V, I _S =1A	-	-	1	V
t _{rr}	Reverse Recovery Time	V _R =50V, I _F =10A , dI/dt=100A/μs	-	67	-	ns
Q _{rr}	Reverse Recovery Charge		-	153	-	nC

Typical Performance Characteristics

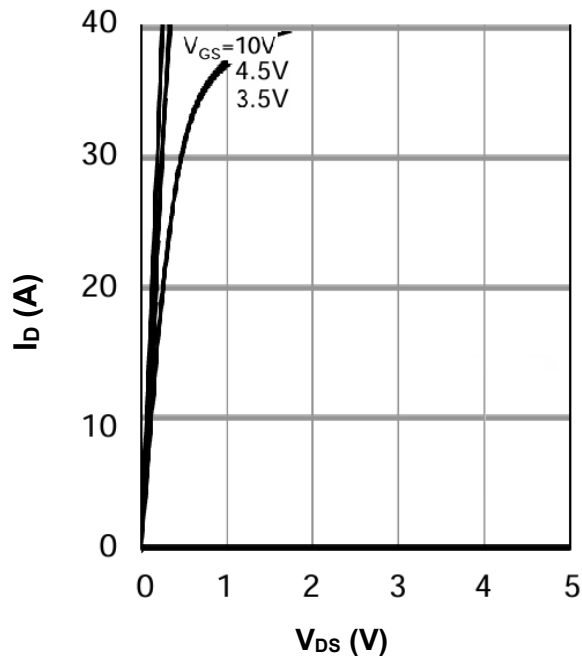


FIG.1 Output Characteristics

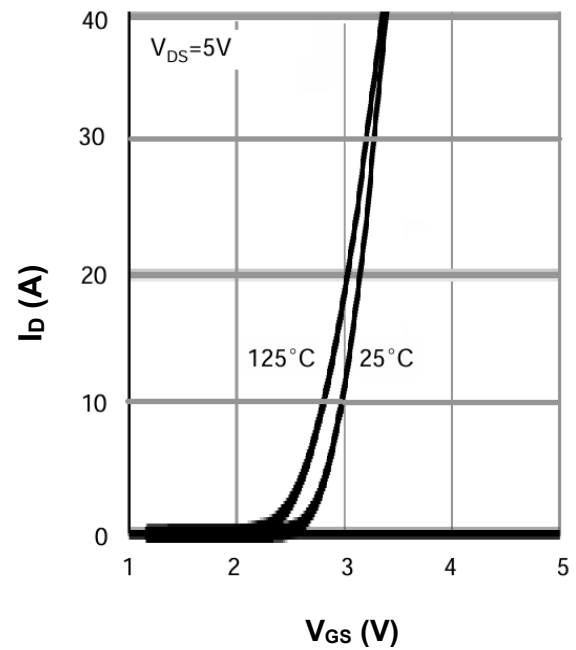


FIG.2 Transfer Characteristics

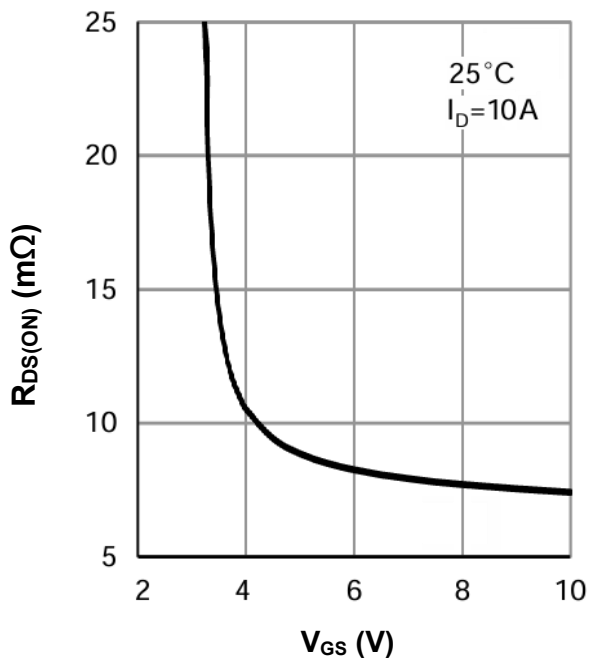


FIG.3 On-Resistance vs. Gate Voltage

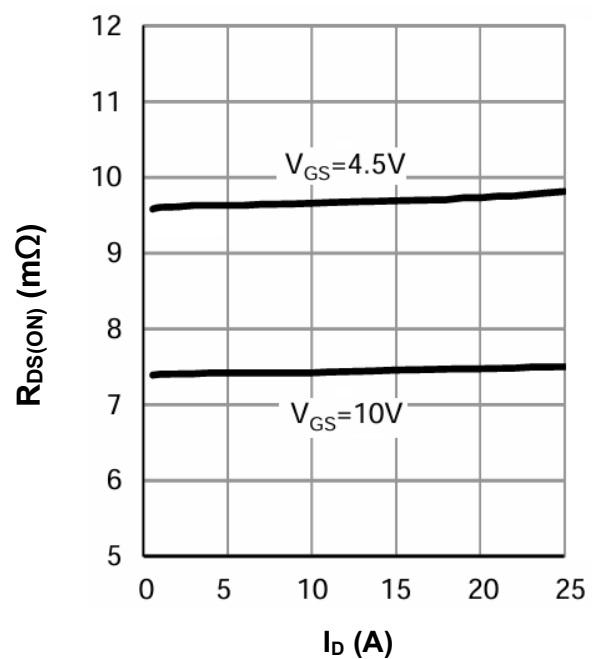


FIG.4 On-Resistance vs. Drain Current

Typical Performance Characteristics

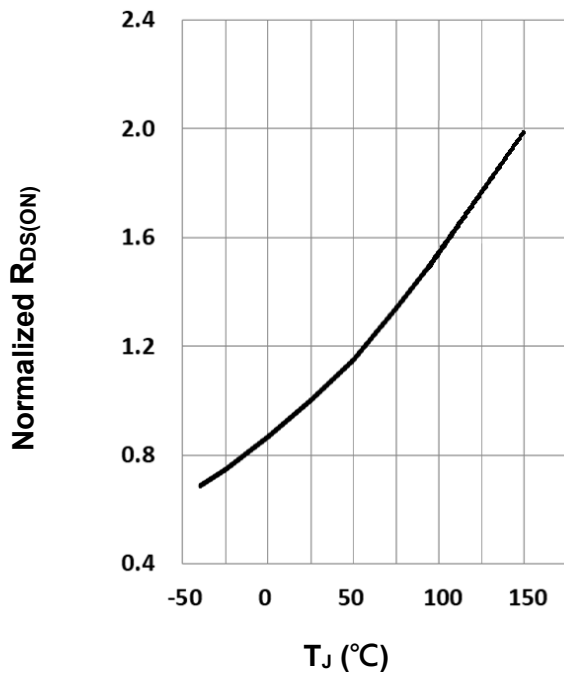


FIG.5 Normalized On-Resistance vs. T_J

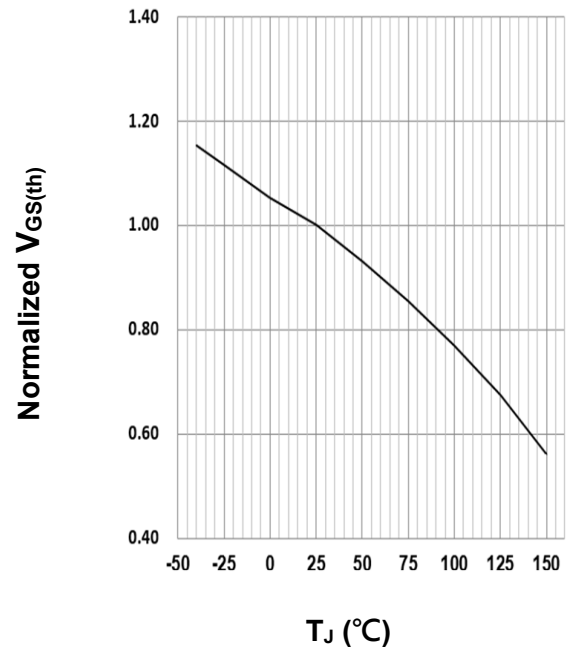


FIG.6 Normalized $V_{GS(th)}$ vs. T_J

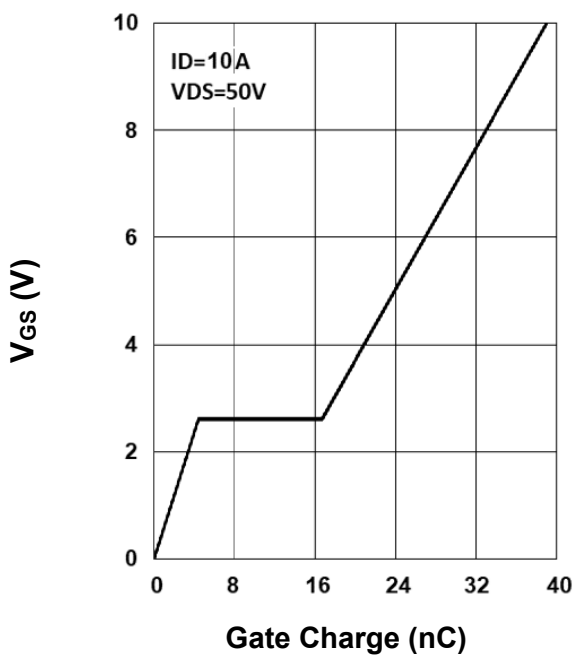


FIG.7 Gate Charge Characteristics

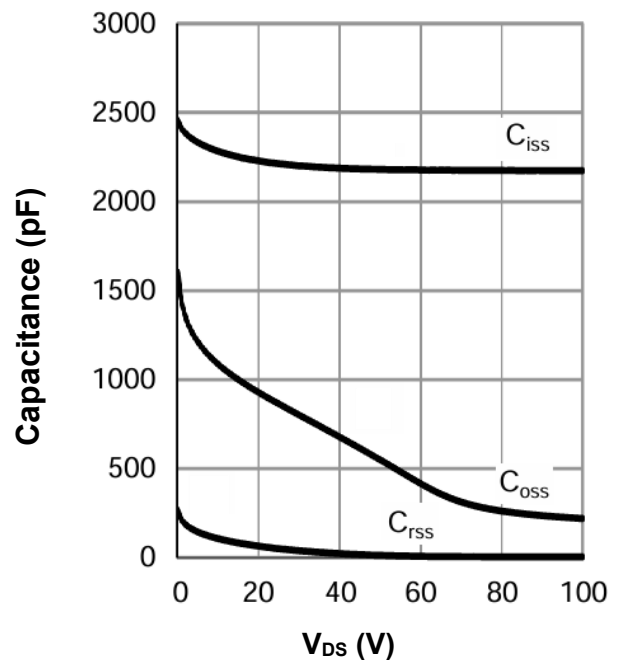
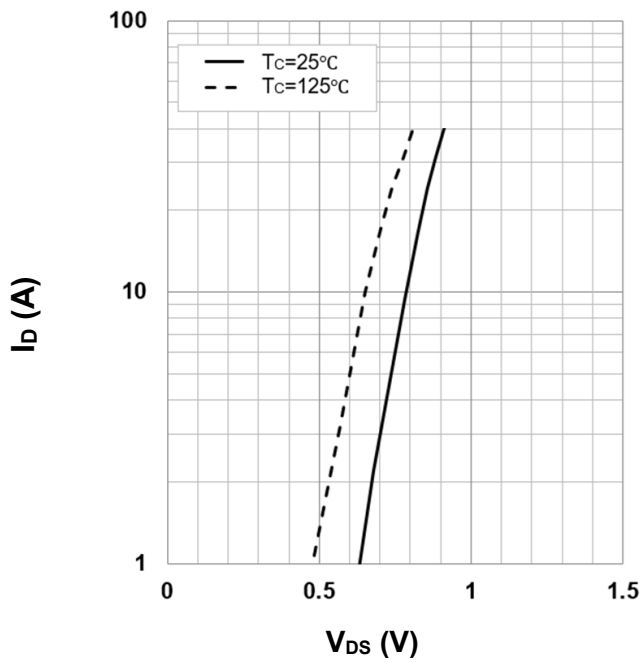
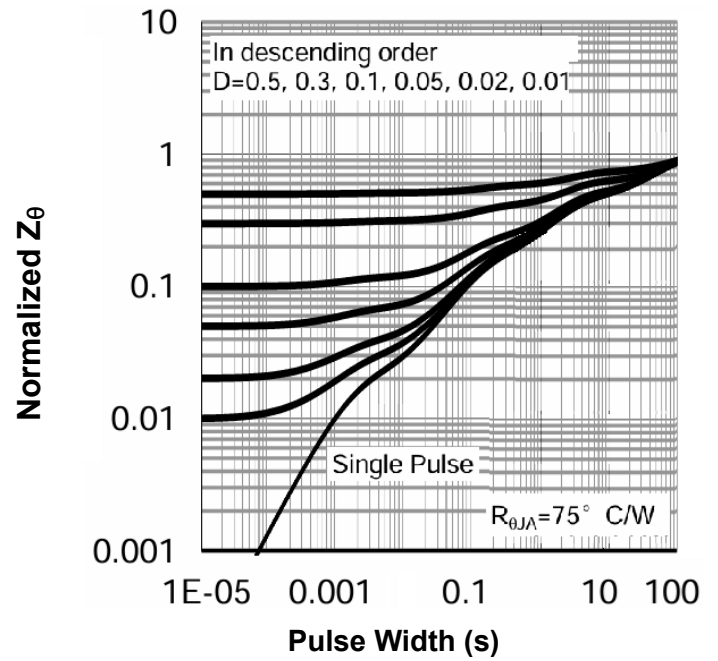
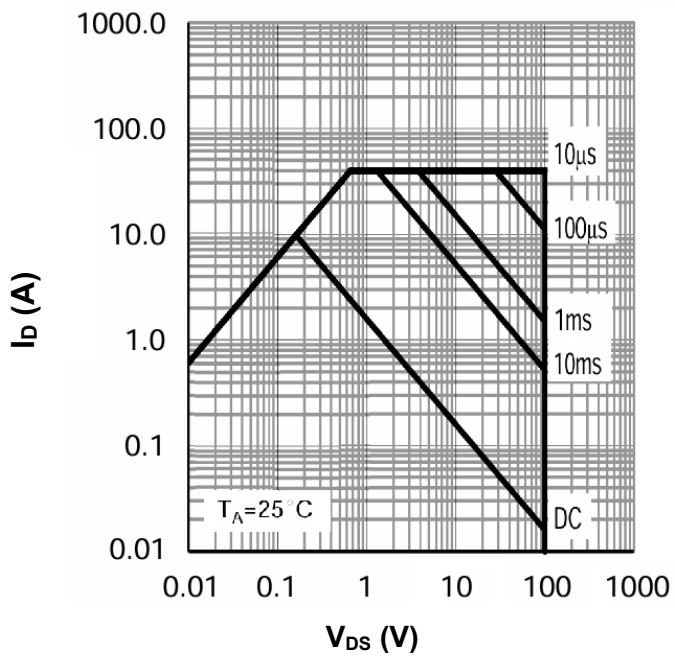


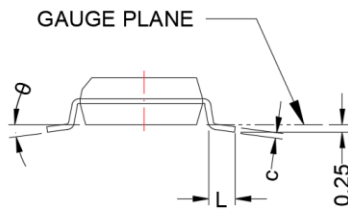
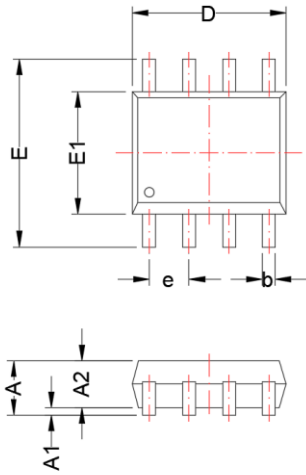
FIG.8 Capacitance Characteristics

Typical Performance Characteristics

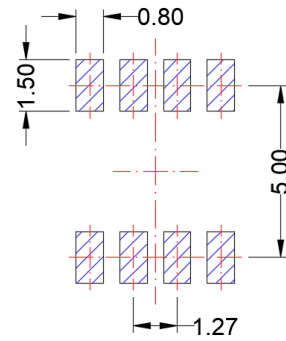


SOP-8L

Package Dimension



Recommended Land Pattern



Unit:mm

Dimensions				
Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A	---	1.75	---	0.069
A1	0.10	0.25	0.004	0.010
A2	1.10	---	0.043	---
b	0.31	0.51	0.012	0.020
c	0.10	0.25	0.004	0.010
D	4.70	5.10	0.185	0.201
E	5.80	6.20	0.228	0.244
E1	3.80	4.00	0.150	0.157
e	1.27 BSC		0.050 BSC	
L	0.40	1.27	0.016	0.050
θ	0°	8°	0°	8°

NOTE:

Dimensions are exclusive of Burrs, Mold Flash and Tie Bar extrusions.

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